

3474AN/R3DB-AFGC/XR/MS

Features

- High luminous intensity output
- Oval Shape
- Well defined spatial radiation
- Wide viewing angle $(2 \theta_{1/2})$: $110^{\circ} / 50^{\circ}$
- UV resistant epoxy
- The product itself will remain within RoHS compliant version



Descriptions

- This precision optical performance oval LED is specifically designed for passenger information signs
- This lamp has matched radiation patterns with yellow, blue or green mixing color applications

Applications

- Color Graphic Signs
- Message boards
- Variable message signs (VMS)
- Commercial outdoor advertising

Device Selection Guide

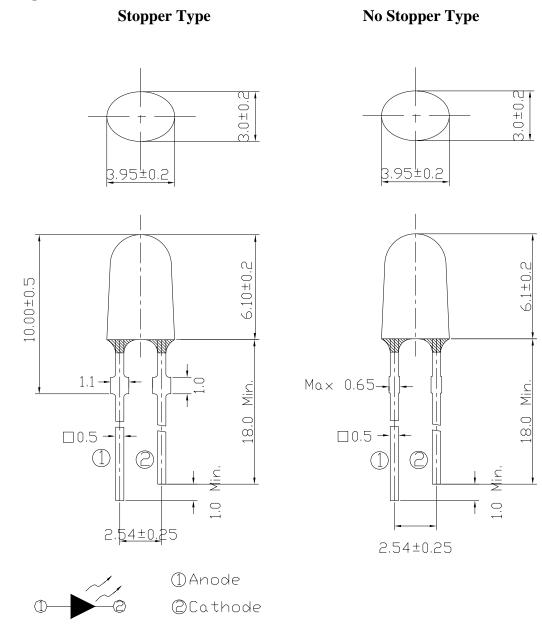
| LED Part No. | Chip Material | Emitted Color | Lens Color | Stopper |
|------------------------|---------------|----------------------|--------------|---------|
| 3474AN/R3DB-AFGC/R/MS | | | | No |
| 3474AN/R3DB-AFGC/PR/MS | AlGaInP | Brilliant Red | Red Diffused | Yes |

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Package Dimensions

3474AN/R3DB-AFGC/XR/MS



Notes:

- Other dimensions are in millimeters, tolerance is 0.25mm except being specified.
- Protruded resin under flange is 1.5mm Max LED.

Everlight Electronics Co., Ltd. Device Number : DT1-347-020 http\\:www.everlight.com Prepared date: 03-10-20088 Rev 1Page: 2 of 10Prepared by: Grace Shen

3474AN/R3DB-AFGC/XR/MS

Absolute Maximum Rating $(T_a=25^{\circ}C)$

| Absolute Maximum Kating $(1_a - 25 C)$ | | | | | | |
|--|----------------------------|-------------------------|------|--|--|--|
| Parameter | Symbol | Absolute Maximum Rating | Unit | | | |
| Forward Current | $I_{\rm F}$ | 50 | mA | | | |
| Pulse Forward Current (Duty1/10@ 1KHz) | \mathbf{I}_{FP} | 160 | mA | | | |
| Operating Temperature | T _{opr} | -40 ~ +85 | °C | | | |
| Storage Temperature | T _{stg} | -40 ~ +100 | °C | | | |
| Soldering Temperature | T_{sol} | 260 | °C | | | |
| Power Dissipation | P _d | 120 | mW | | | |
| Reverse Voltage | Vr | 5 | V | | | |
| Electrostatic Discharge | ESD | 2К | V | | | |

Notes: Soldering time ≤ 5 seconds.

Electro-Optical Characteristics (T_a=25°C)

| Parameter | Symbol | Min. | Тур. | Max. | Unit | Condition |
|---------------------|----------------------|------|-----------|------|---------|-----------------------|
| Luminous Intensity | I_V | 510 | | 1020 | mcd | |
| Viewing Angle | $2	heta$ $_{ m 1/2}$ | | X:110Y:50 | | deg | |
| Peak Wavelength | λp | | 632 | | | T 2 0 A |
| Dominant Wavelength | λ_d | 620 | | 632 | nm | I _F =20mA |
| Spectrum Half width | Δλ | | 20 | | | |
| Forward Voltage | V _F | 2.0 | | 2.6 | V | |
| Reverse Current | I _R | | | 10 | μA | V _R =5V |

Rank Combination (I_F=20mA)

| Rank | F1 | F2 | G1 | G2 |
|--------------------|---------|---------|---------|----------|
| Luminous Intensity | 510~610 | 610~720 | 720~860 | 860~1020 |

*Measurement Uncertainty of Luminous Intensity: ±10%

| Rank | 1 | 2 | |
|---------------------|---------|---------|--|
| Dominant Wavelength | 620~626 | 626~632 | |

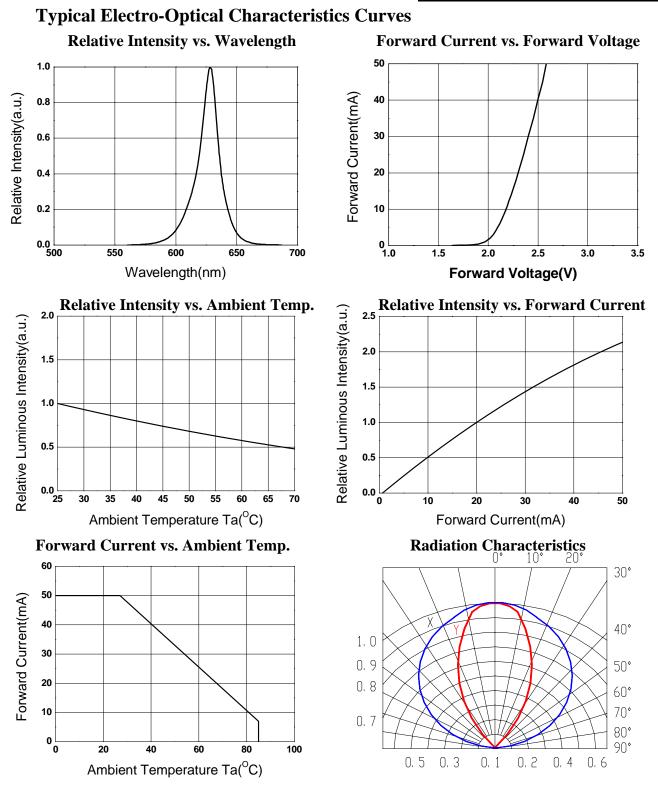
*Measurement Uncertainty of Dominant Wavelength ±1.0nm

Unit:nm

Unit:mcd



3474AN/R3DB-AFGC/XR/MS

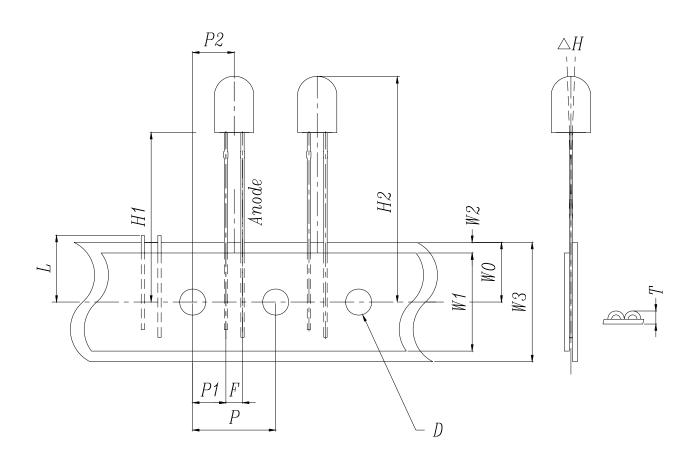


Everlight Electronics Co., Ltd. Device Number : DT1-347-020 http\\:www.everlight.com Prepared date: 03-10-20088 Rev 1 Page: 4 of 10 Prepared by: Grace Shen



3474AN/R3DB-AFGC/XR/MS

Taping Dimensions



Everlight Electronics Co., Ltd. Device Number : DT1-347-020 http\\:www.everlight.com Prepared date: 03-10-20088 Rev 1 Page: 5 of 10 Prepared by: Grace Shen



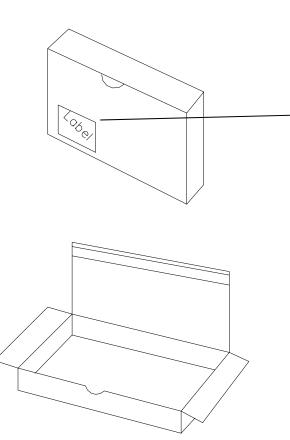
3474AN/R3DB-AFGC/XR/MS

| Taping Sizes | | | | |
|---------------------------------------|---------------|----------------|-------|-----------|
| | | Specifications | | |
| Symbol Items | Symbol | Avg. | | Tolerance |
| | | mm | Inch | (mm) |
| Tape Feed Hole Diameter | D | 4.00 | 0.157 | ±0.2 |
| Component Lead Pitch | F | 2.54 | 0.100 | ±0.3 |
| Front-to-Read Deflection | $\triangle H$ | 2.0 | 0.078 | Max |
| Feed Hole to Button of Component | H1 | 18.5 | 0.729 | ±1.0 |
| Feed Hole to Overall Component Height | H2 | 24.6 | 0.969 | ±1.0 |
| Lead Length after Component Removal | L | 11.00 | 0.433 | Max |
| Feed Hole Pitch | Р | 12.70 | 0.500 | ±0.3 |
| Lead Location | P1 | 5.10 | 0.200 | ±0.7 |
| Center of Component Location | P2 | 6.35 | 0.250 | ±1.2 |
| Overall Taped Package Thickness | Т | 1.42 | 0.056 | Max |
| Feed Hole Location | W0 | 9.00 | 0.354 | ±0.5 |
| Adhesive Tape Width | W1 | 13.00 | 0.512 | ±0.5 |
| Adhesive Tape Position | W2 | 4.00 | 0.157 | Max |
| Tape Width | W3 | 18.00 | 0.709 | ±0.75 |

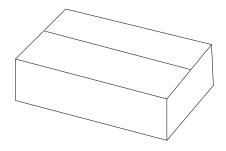


Packing Specification

Inner Carton



Outside Carton



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| EVERLIGHT | | | | |
|---------------------------------------|--------|--|--|--|
| CPN: | | | | |
| P/N:XXXXXXXXX | | | | |
| | RoHS | | | |
| XXX/XXXX-XXXX | | | | |
| QTY : XXXX | CAT:XX | | | |
| | HUE:XX | | | |
| LOT NO: | REF:XX | | | |
| , , , , , , , , , , , , , , , , , , , | | | | |
| MADE IN TAIWAN | 1 | | | |

- Label Form Specification
 CPN: Customer's Production Number
 P/N : Production Number
 QTY: Packing Quantity
 CAT: Rank of Luminous Intensity
 HUE: Rank of Dominant Wavelength
 REF: Reference
 LOT No: Lot Number
 MADE IN TAIWAN: Production Place
- Packing Quantity
 - 1. 2500 PCS/1 Inner Carton
 - 2. 10Inner Cartons/1 Outside Carton

Everlight Electronics Co., Ltd. Device Number : DT1-347-020 http\\:www.everlight.com Prepared date: 03-10-20088



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Notes

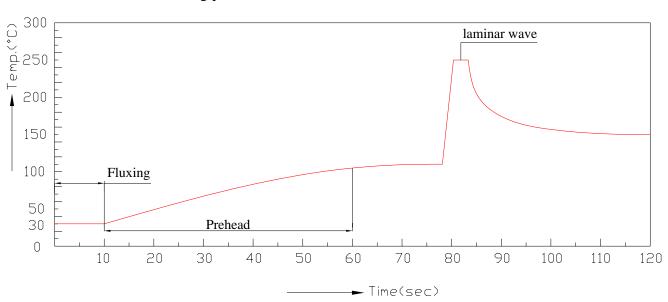
- 1. Lead Forming
 - During lead formation, the leads should be bent at a point at least 3mm from the base of the epoxy bulb.
 - Lead forming should be done before soldering.
 - Avoid stressing the LED package during leads forming. The stress to the base may damage the LED's characteristics or it may break the LEDs.
 - Cut the LED leadframes at room temperature. Cutting the leadframes at high temperatures may cause failure of the LEDs.
 - When mounting the LEDs onto a PCB, the PCB holes must be aligned exactly with the lead position of the LED. If the LEDs are mounted with stress at the leads, it causes deterioration of the epoxy resin and this will degrade the LEDs.
- 2. Storage
 - The LEDs should be stored at 30°C or less and 70%RH or less after being shipped from Everlight and the storage life limits are 3 months. If the LEDs are stored for 3 months or more, they can be stored for a year in a sealed container with a nitrogen atmosphere and moisture absorbent material.
 - Please avoid rapid transitions in ambient temperature, especially, in high humidity environments where condensation can occur.
- 3. Soldering
 - Careful attention should be paid during soldering. When soldering, leave more then 3mm from solder joint to epoxy bulb, and soldering beyond the base of the tie bar is recommended.

| Hand Soldering | | DIP Soldering | | |
|----------------------|-----------------|-------------------|-----------------------|--|
| Town at the of ince | 300°C Max. (30W | Duck and former | 100°C Max. (60 sec | |
| Temp. at tip of iron | Max.) | Preheat temp. | Max.) | |
| Soldering time | 3 sec Max. | Bath temp. & time | 260 Max., 5 sec Max | |
| Distance | 3mm Min.(From | Distance | 3mm Min. (From | |
| | solder joint to | | solder joint to epoxy | |
| | epoxy bulb) | | bulb) | |

Recommended soldering conditions:

http\\:www.everlight.com Prepared date: 03-10-20088 Rev 1Page: 8 of 10Prepared by: Grace Shen





Recommended soldering profile

3474AN/R3DB-AFGC/XR/MS

- Avoiding applying any stress to the lead frame while the LEDs are at high temperature particularly when soldering.
- Dip and hand soldering should not be done more than one time
- After soldering the LEDs, the epoxy bulb should be protected from mechanical shock or vibration until the LEDs return to room temperature.
- A rapid-rate process is not recommended for cooling the LEDs down from the peak temperature.
- Although the recommended soldering conditions are specified in the above table, dip or handsoldering at the lowest possible temperature is desirable for the LEDs.
- Wave soldering parameter must be set and maintain according to recommended temperature and dwell time in the solder wave.
- 4. Cleaning
 - When necessary, cleaning should occur only with isopropyl alcohol at room temperature for a duration of no more than one minute. Dry at room temperature before use.
 - Do not clean the LEDs by the ultrasonic. When it is absolutely necessary, the influence of ultrasonic cleaning on the LEDs depends on factors such as ultrasonic power and the assembled condition. Ultrasonic cleaning shall be pre-qualified to ensure this will not cause damage to the LED

3474AN/R3DB-AFGC/XR/MS

- 5. Heat Management
 - Heat management of LEDs must be taken into consideration during the design stage of LED application. The current should be de-rated appropriately by referring to the de-rating curve found in each product specification.
 - The temperature surrounding the LED in the application should be controlled. Please refer to the data sheet de-rating curve.
- 6. ESD (Electrostatic Discharge)
 - Electrostatic discharge (ESD) or surge current (EOS) can damage LEDs.
 - An ESD wrist strap, ESD shoe strap or antistatic gloves must be worn whenever handling LEDs.
 - All devices, equipment and machinery must be properly grounded.
 - Use ion blower to neutralize the static charge which might have built up on surface of the LEDs plastic lens as a result of friction between LEDs during storage and handing.
- 7. Other
 - Above specification may be changed without notice. EVERLIGHT will reserve authority on material change for above specification.
 - When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
 - These specification sheets include materials protected under copyright of EVERLIGHT corporation. Please don't reproduce or cause anyone to reproduce them without EVERLIGHT's consent.

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